

XPG Lancer Blade memory module 32 GB 2 x 16 GB DDR5 6400 MT/s 288-pin DIMM ECC

Gamintojas: **ADATA** · Modelis: **AX5U6400C3216G-DTLABWH** · EAN: **4711085944634** · Prekės kodas: **640434**



825,90 €

Kaina su PVM

Be PVM: **682,56 €**

Sandėlyje



Prekė internetu

Nuskenaukite kodą arba apsilankykite www.shopro.lt

Pagrindinės savybės

- ✓ Compact Low-Profile Heatsink Design
- ✓ PMIC for power supply stability
- ✓ On-die ECC error correction
- ✓ High-quality materials for stable overclocking
- ✓ Works with the Latest AMD Platforms
- ✓ Supports Intel® XMP 3.0 and AMD EXPO for easy overclocking



Aprašymas

LANCER BLADE DDR5 SLEEK EFFICIENCY, COMPACT POWER

Compact Low-Profile Heatsink Design

The LANCER BLADE boasts a low-profile heatsink that fits perfectly in smaller PC cases and avoids interference with tower CPU coolers. Its sleek geometric lines add versatility and visual appeal to any case design.

Enhanced Power Management

The XPG LANCER BLADE DDR5 features a built-in Power Management IC (PMIC) that enhance power supply stability. It's lower operating voltage also make LANCER more power-efficient than DDR4.

Stability and Reliability

With On-die error correcting code (ECC), this DDR5 memory module can correct errors in real-time to provide increased stability and reliability.

Made with High-Quality Materials

High-quality ICs and PCBs ensure uncompromised performance and reliable overclocking, ideal for discerning gamers and overclockers.

AMD EXPO

Support for AMD EXPO (Extended Profiles for Overclocking) and compatibility with the latest platforms for reliability and stability.

Overclocking Made Easy

With support for Intel XMP 3.0, get overclocking easily without the need to hassle with BIOS settings. There is no need to repeatedly adjust and fine-tune overclocking parameters.

Techninė specifikacija

Specifications	
Sandėlio grupė	Arbeitsspeicher [+806][-147]
Features	
Internal memory	32 GB
Memory layout (modules x size)	2 x 16 GB
Internal memory type	DDR5
Memory data transfer rate	6400 MT/s
Component for	PC
Memory form factor	288-pin DIMM
ECC	Yes
On-Die ECC	Yes
CAS latency	32
Intel Extreme Memory Profile (XMP)	Yes
Intel Extreme Memory Profile (XMP) version	3
AMD Extended Profiles for Overclocking (EXPO)	Yes
Cooling type	Heatsink
Operational conditions	
Operating temperature (T-T)	0 - 85 °C
Storage temperature (T-T)	-20 - 65 °C
Weight & dimensions	
Width	133.3 mm
Depth	33.8 mm
Height	7.8 mm
Weight	36.2 g

Packaging data

Package width	141 mm
Package depth	170 mm
Package height	12.2 mm
Package weight	113 g
Package type	Blister